

## N-Channel 100 V (D-S) MOSFET

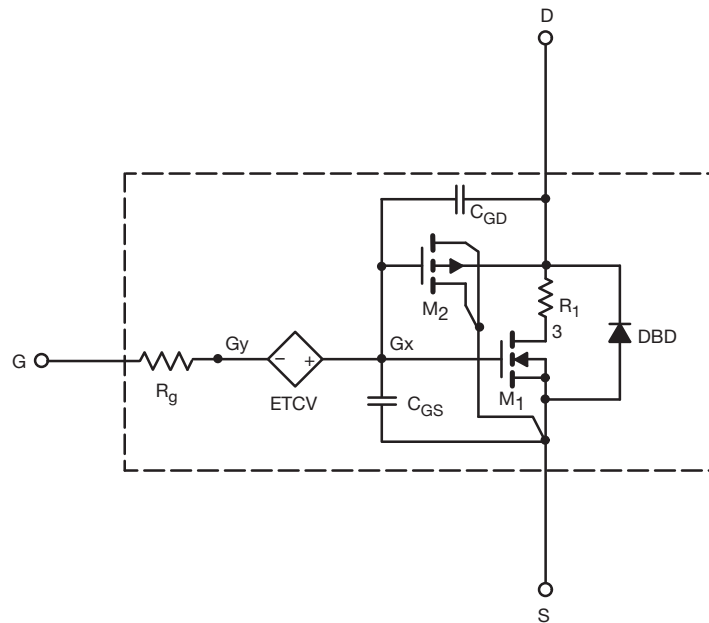
### DESCRIPTION

The attached SPICE model describes the typical electrical characteristics of the N-Channel vertical DMOS. The subcircuit model is extracted and optimized over the -55 °C to +150 °C temperature ranges under the pulsed -20 V to +20 V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage. A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched  $C_{gd}$  model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

### CHARACTERISTICS

- N-channel vertical DMOS
- Macro model (subcircuit model)
- Level 3 MOS
- Apply for both linear and switching application
- Accurate over the -55 °C to +150 °C temperature range
- Model the gate charge

### SUBCIRCUIT MODEL SCHEMATIC



### Note

- This document is intended as a SPICE modeling guideline and does not constitute a commercial product datasheet. Designers should refer to the appropriate datasheet of the same number for guaranteed specification limits



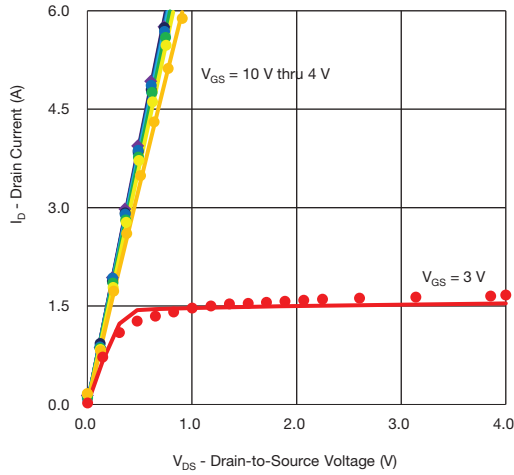
| SPECIFICATIONS ( $T_C = 25\text{ }^\circ\text{C}$ , unless otherwise noted) |              |  |                |               |          |
|---|--------------|--|----------------|---------------|----------|
| PARAMETER   | SYMBOL       | TEST CONDITIONS  | SIMULATED DATA | MEASURED DATA | UNIT     |
| <b>Static</b>   |              |  |                |               |          |
| Gate-source threshold voltage   | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$  | 2.1            | -             | V        |
| Drain-source on-state resistance <sup>a</sup>                               | $R_{DS(on)}$ | $V_{GS} = 10\text{ V}, I_D = 2\text{ A}$   | 0.125          | 0.124         | $\Omega$ |
|   |              | $V_{GS} = 4.5\text{ V}, I_D = 1\text{ A}$  | 0.141          | 0.138         |          |
| Forward transconductance <sup>a</sup>                                       | $g_{fs}$     | $V_{DS} = 20\text{ V}, I_D = 2\text{ A}$   | 8              | 12            | S        |
| <b>Dynamic <sup>b</sup></b>   |              |  |                |               |          |
| Input capacitance   | $C_{iss}$    | $V_{DS} = 50\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$                              | 288            | 290           | pF       |
| Output capacitance  | $C_{oss}$    |  | 27             | 26            |          |
| Reverse transfer capacitance  | $C_{rss}$    |  | 5              | 5             |          |
| Total gate charge   | $Q_g$        | $V_{DS} = 50\text{ V}, V_{GS} = 10\text{ V}, I_D = 0.5\text{ A}$                           | 4.7            | 4.7           | nC       |
|   |              |  | 2.2            | 2.2           |          |
| Gate-source charge  | $Q_{gs}$     | $V_{DS} = 50\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 0.5\text{ A}$                          | 0.7            | 1             |          |
| Gate-drain charge   | $Q_{gd}$     |  | 0.8            | 0.5           |          |
| <b>Drain-source body diode characteristics</b>                              |              |  |                |               |          |
| Body diode voltage  | $V_{SD}$     | $I_S = 1.6\text{ A}$   | 0.84           | 0.8           | V        |
| Body diode reverse recovery time  | $t_{rr}$     | $I_F = 1.6\text{ A}$<br>$di/dt = 100\text{ A}/\mu\text{s}, T_J = 25\text{ }^\circ\text{C}$ | 21             | 21            | ns       |
| Body diode reverse recovery charge  | $Q_{rr}$     |  | 18             | 21            | nC       |
| Reverse recovery fall time  | $t_a$        |  | 17             | 19            | ns       |
| Reverse recovery rise time  | $t_b$        |  | 4              | 2             |          |

**Notes**

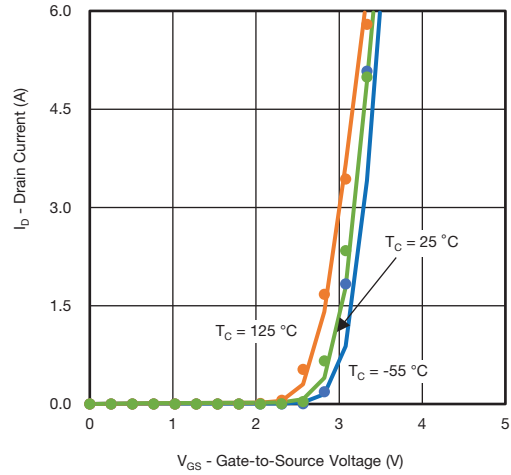
- a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$   
b. Guaranteed by design, not subject to production testing



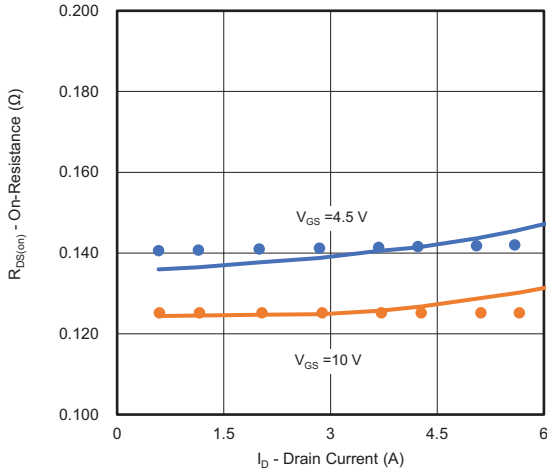
## COMPARISON OF MODEL WITH MEASURED DATA ( $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted)



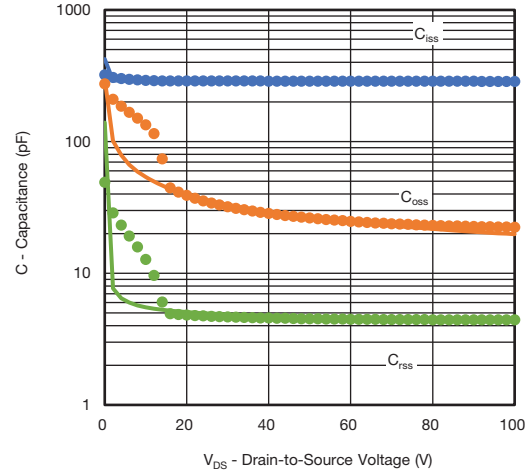
**Output Characteristics**



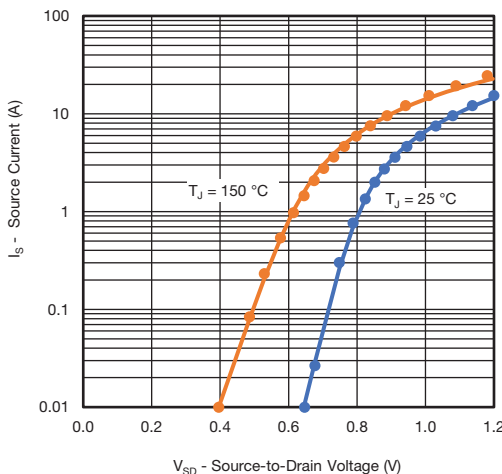
**Transfer Characteristics**



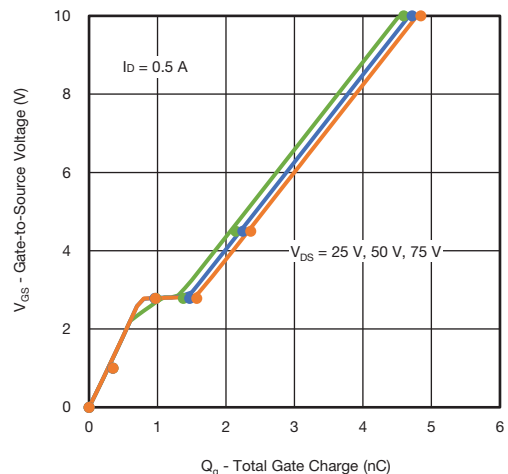
**On-Resistance vs. Drain Current (A)**



**Capacitance**



**Source-Drain Diode Forward Voltage**



**Gate Charge**

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